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Vishay Siliconix

# Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0060			
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0078			
I <sub>D</sub> (A)	30			
Configuration	Single			
Package	TO-252			

#### **FEATURES**

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R<sub>q</sub> and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>







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N-Channel MOSFET	) S

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	40	V
Gate-source voltage		V <sub>GS</sub>	± 20	V
Continuous drain current <sup>a</sup>	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	30	
	T <sub>C</sub> = 125 °C		30	
Continuous source current (diode conduction) <sup>a</sup>		Is	30	Α
Pulsed drain current <sup>b</sup>		I <sub>DM</sub>	120	
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	24	
Single pulse avalanche energy	L = U.1 Min	E <sub>AS</sub>	28.8	mJ
Maximum power dissipation	T <sub>C</sub> = 25 °C	D	62	W
	T <sub>C</sub> = 125 °C	- P <sub>D</sub>	20	VV
Operating junction and storage temperature	range	T <sub>J</sub> , T <sub>stq</sub>	-55 to +175	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount c	$R_{thJA}$	50	°C/W	
Junction-to-case (drain)	e (drain)		2.4	C/VV	

### Notes

- a. Package limited
- b. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static		•					l	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		1.7	2.2	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V	-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 125 °C	-	-	50	μA	
-		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	250	μΑ	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 \text{ V}$	20	-	-	Α	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 15 A	-	0.0046	0.0060		
During and a solution of the s	Б	V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 10 A	-	0.0060	0.0078	Ω	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 15 A, T <sub>J</sub> = 125 °C	-	-	0.0091		
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 15 A, T <sub>J</sub> = 175 °C	-	=.	0.0107	_	
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 15 A	-	62	-	S	
Dynamic <sup>b</sup>		•			1		•	
Input capacitance	C <sub>iss</sub>			-	1844	2600		
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 25 V, f = 1 MHz	-	527	750	pF	
Reverse transfer capacitance	C <sub>rss</sub>	1		-	56	80		
Total gate charge <sup>c</sup>	Qq			-	34.5	52		
Gate-source charge c	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V V <sub>DS</sub> = 20 V, I <sub>D</sub> = 15 A		-	6.1	-	nC	
Gate-drain charge <sup>c</sup>	Q <sub>qd</sub>	1			6.6	-		
Gate resistance	R <sub>q</sub>		f = 1 MHz		2.91	4.37	Ω	
Turn-on delay time c	t <sub>d(on)</sub>			-	12	25		
Rise time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub> =	20 V, $R_L$ = 1.33 Ω	-	7	15		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 15 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		-	28	50	ns	
Fall time c	t <sub>f</sub>			-	10	20		
Source-Drain Diode Ratings and Chara	cteristics <sup>b</sup>							
Pulsed current a	I <sub>SM</sub>			-	-	120	Α	
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = 15 A, V <sub>GS</sub> = 0 V		-	0.83	1.5	V	
Body diode reverse recovery time	t <sub>rr</sub>	l <sub>F</sub> = 10 A, di/dt = 100 A/μs		-	26	52	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>			-	13	26	nC	
Reverse recovery fall time	t <sub>a</sub>			-	11	-		
Reverse recovery rise time	t <sub>b</sub>			_	15	-	ns	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-0.86	-	Α	

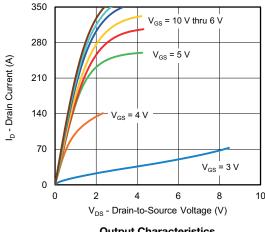
### **Notes**

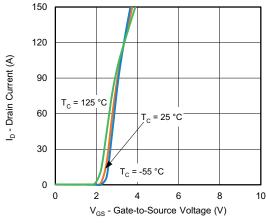
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



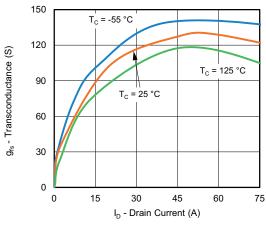
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

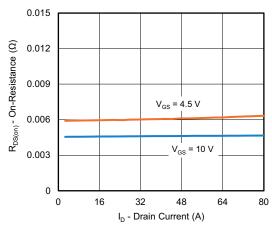






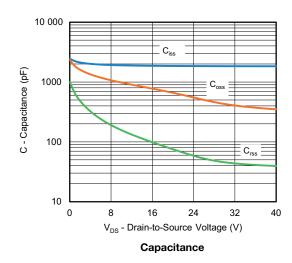


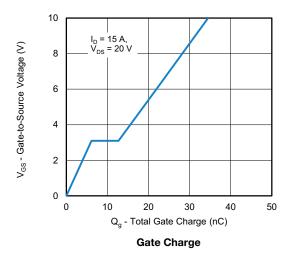




**Transconductance** 

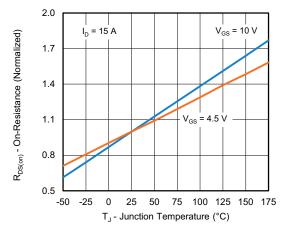
On-Resistance vs. Drain Current



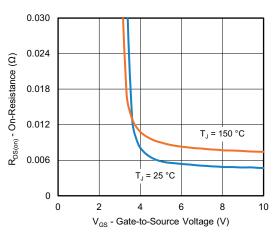




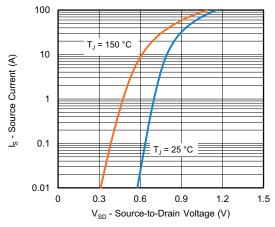
### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



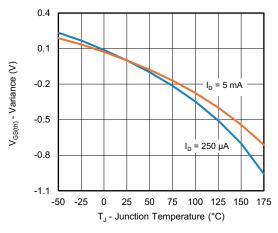
On-Resistance vs. Junction Temperature



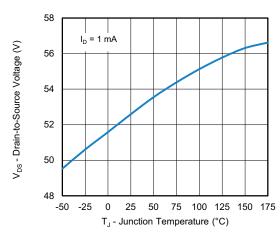
On-Resistance vs. Gate-to-Source Voltage



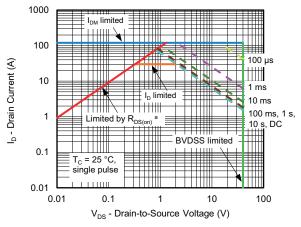
Source Drain Diode Forward Voltage



**Threshold Voltage** 



**Drain Source Breakdown vs. Junction Temperature** 



Safe Operating Area

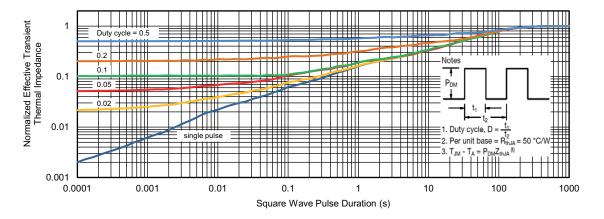
#### Note

a.  $V_{GS} > minimum V_{GS}$  at which  $R_{DS(on)}$  is specified

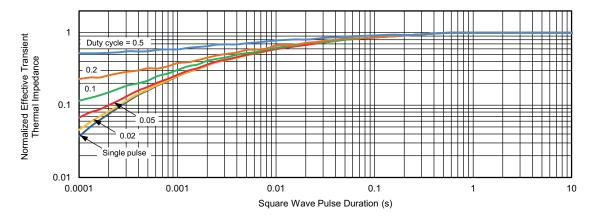
For technical questions, contact: automostechsu



### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

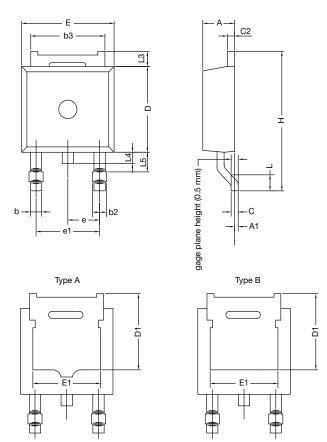
#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
    Normalized Transient Thermal Impedance Junction-to-Case (25 °C)
  - are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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## **TO-252AA Case Outline**



DIM.	MILLII	METERS	INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	4.10	-	0.161	-
Е	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
е	2.28 BSC		0.090	BSC
e1	4.56 BSC		0.180	) BSC
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.01	1.52	0.040	0.060

ECN: T25-0122-Rev. C, 12-May-2025 DWG: 6019

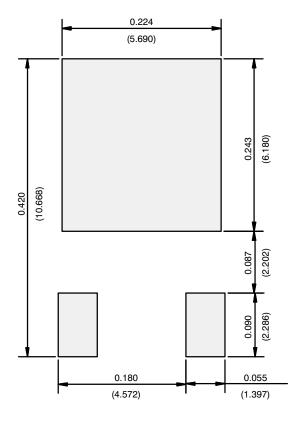
### Notes

- Dimension L3 is for reference only
- Dimension D1 and E1 on type A and B is the same

Revision: 12-May-2025 1 Document Number: 64424



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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